



Re application of:
Rich Fogal and Michael B. Ball

Serial No.: 09/422,887

Filed: October 21, 1999

For: ANGULARLY OFFSET STACKED
DIE MULTICHIP DEVICE AND
METHOD OF MANUFACTURE

§ Group Art Unit: 2822
§
§ Examiner: J. Brophy
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§ Atty. Docket: 95-0134.05
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Certificate of Mailing (37 C.F.R. § 1.8)

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1/17/03
Date

Susan Jerome
Signature

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136(a)

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Applicants hereby petition to extend the period for filing an Appeal Brief after the Notice of Appeal received by the Patent and Trademark Office October 8, 2002 for two(2) month(s), from December 8, 2002 to February 8, 2003.

Accordingly, the requisite fee is \$ 410. The Commissioner is requested to charge this fee, and any additional fee which may be required, to Micron Technology, Inc. Deposit Account 13-3092, Order No. 95-0134.05. A duplicate copy of this petition is enclosed.

Respectfully submitted,

Charles Brantley

Date: 1/15/03

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